#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (V <sub>CC</sub> to V <sub>EE</sub> )	12V
Input Voltage(VEE - 0.3V) to (VCC + 0	.3V)
All Other Pins(VEE - 0.3V) to (VCC + 0	.3V)
Output Current±120	)mA
Short-Circuit Duration (Vout to GND, Vcc or VEE)Continu	ous
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	
8-Pin SO (derate 5.9mW/°C above +70°C)471	mW
8-Pin µMAX (derate 4.1mW/°C above +70°C)330	)mW

	14-Pin SO (derate 8.3mW/°C above +70°C)	667mW
	16-Pin SO (derate 8.7mW/°C above +70°C)	696mW
	16-Pin QSOP (derate 8.3mW/°C above +70°C	)667mW
0	perating Temperature Range	40°C to +85°C
	orage Temperature Range	
Le	ead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

(VCC = +5V, VEE = 0V, SHDN ≥ 4V, RL = ∞, VOUT = 2.5V, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CON	DITIONS	MIN	TYP	MAX	UNITS
Operating Supply Voltage Range	V <sub>CC</sub>	Inferred from PSRR te	4.0		10.5	V	
		MAX4310/MAX4311/N CMRR test	MAX4310/MAX4311/MAX4312, inferred from CMRR test			C - 2.8	
Input Voltage Range		MAX4313/MAX4314/N output voltage swing	MAX4315, inferred from	0.035	V	<sub>CC</sub> - 2.7	V
Common-Mode Rejection Ratio	CMRR	$0 \le V_{CM} \le 2.2V$ , MAX- only	4310/MAX4311/MAX4312	73	95		dB
Input Offset Voltage	Vos				±5.0	±20	mV
Input Offset Voltage Drift	TCvos				±7		μV/°C
Input Offset Voltage Matching				±1		mV	
Input Bias Current	ΙΒ	IIN		7	14	μΑ	
Feedback Bias Current	I <sub>FB</sub>	IFB, MAX4310/MAX4311/MAX4312 only			7	14	μΑ
Input Offset Current	los	MAX4310/MAX4311/N	MAX4312 only		0.1	2	μΑ
Common-Mode Input Resistance	R <sub>IN</sub>	V <sub>IN</sub> varied over V <sub>CM</sub> , I MAX4312 only	MAX4310/MAX4311/		3		МΩ
Differential Input Resistance	RIN				70		ΚΩ
		MAX4310/MAX4311/	Open loop		8		
Output Resistance	Rout	MAX4312 only	Closed loop, $A_V = +1V/V$		0.025		Ω
		MAX4313/MAX4314/N	MAX4313/MAX4314/MAX4315		0.025		
Disabled Output Resistance	Rout	MAX4310/MAX4311/MAX4312, open loop			35		Ω
Disabled Output Hesistance	11001	MAX4313/MAX4314/MAX4315			1		32
Open-Loop Gain	Avol	MAX4310/MAX4311/N R <sub>L</sub> = 150 $\Omega$ to GND, 0.	50	59		dB	
Voltage Gain	Avcl	MAX4313/MAX4314/N R <sub>L</sub> = 150 $\Omega$ to GND, 0.	,	1.9	2.0	2.1	V/V

#### DC ELECTRICAL CHARACTERISTICS (continued)

(V<sub>CC</sub> = +5V, V<sub>EE</sub> = 0V, SHDN ≥ 4V, R<sub>L</sub> = ∞, V<sub>OUT</sub> = 2.5V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONE	MIN	TYP	MAX	UNITS	
		D: 1500	V <sub>CC</sub> - V <sub>OH</sub>		0.73	0.9	
Outrant Valtage Contra	\/a=	$R_L = 150\Omega$	V <sub>OL</sub> - V <sub>EE</sub>		0.03	0.06	V
Output Voltage Swing	V <sub>OUT</sub>	D. 10k0	VCC - VOH		0.25	0.4	v
		$R_L = 10k\Omega$	V <sub>OL</sub> - V <sub>EE</sub>		0.04	0.07	
Output Current	lout	$R_L = 30\Omega$		±75	±95		mA
Power-Supply Rejection Ratio	PSRR	V <sub>CC</sub> = 4.0V to 10.5V		52	63		dB
		MAX4310/MAX4313			6.1	7.8	
Quiescent Supply Current	Icc	MAX4311/MAX4314			6.9	8.8	mA
		MAX4312/MAX4315			7.4	9.4	
Shutdown Supply Current		SHDN ≤ V <sub>IL</sub>			560	750	μΑ
LOGIC CHARACTERISTICS (	SHDN, A0, A	1, A2)					
Logic-Low Threshold	VIL					VEE + 1	V
Logic-High Threshold	V <sub>IH</sub>			V <sub>CC</sub> - 1	•	•	V
Logic-Low Input Current	IJΕ	$V_{IL} \le V_{EE} + 1V$	•	-500	-320		μΑ
Logic-High Input Current	liH	V <sub>IH</sub> ≥ V <sub>CC</sub> - 1V			0.3	5	μΑ

#### **AC ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega, V_{CM} = 1.5V, A_{VCL} = +1V/V (MAX4310/MAX4311/MAX4312), A_{VCL} = +2V/V (MAX4313/MAX4314/MAX4315), T_A = +25°C, unless otherwise noted.)$ 

PARAMETER	SYMBOL	CONDITIO	NS	MIN	TYP	MAX	UNITS	
			MAX4310		280			
			MAX4311	;	345			
-3dB Bandwidth	DW/ a in	\/a= 100m\/n n	MAX4312	2	265		MHz	
-30b bandwidth	BW <sub>(-3dB)</sub>	$V_{OUT} = 100 \text{mVp-p}$	MAX4313		150		IVITZ	
			MAX4314		127			
			MAX4315		97			
			MAX4310		60			
			MAX4311		40			
-0.1dB Bandwidth	BW(-0.1dB)	BW(-0.1dB)	\/ a. = 100m\/n n	MAX4312		35		MHz
-U. Tab Banawatn			V <sub>OUT</sub> = 100mVp-p	MAX4313		40		IVITZ
				MAX4314		78		
			MAX4315		46			

#### AC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega, V_{CM} = 1.5V, A_{VCL} = +1V/V (MAX4310/MAX4311/MAX4312), A_{VCL} = +2V/V (MAX4313/MAX4314/MAX4315), T_A = +25°C, unless otherwise noted.)$ 

PARAMETER	SYMBOL		CONDITIONS		MIN	TYP	MAX	UNITS
			MAX4310			110		
			MAX4311			100		
E    D	FPBW	.,	MAX4312			80		
Full-Power Bandwidth		Vout = 2Vp-p	MAX4313			40		MHz
			MAX4314			90		1
			MAX4315			70		
			MAX4310			460		
			MAX4311			430		
0	0.0	.,	MAX4312			345		
Slew Rate	SR	V <sub>OUT</sub> = 2Vp-p	MAX4313			540		
			MAX4314			430		
			MAX4315			310		
			MAX4310/MA	X4311/MAX4312		42		
Settling Time to 0.1%	ts	$V_{OUT} = 2Vp-p$	MAX4313/MA	X4314/MAX4315		25		ns
Gain Matching		Matching between bandwidth	en channels ove		0.05		dB	
Differential Gain Error	$A_{VCL} = +1V/V, \\ R_L = 150\Omega \text{ to} \\ VCC/2 \\ MAX4310/MAX4311/ \\ MAX4312$		AX4311/		0.06		%	
		$R_L = 150\Omega$ to $V_{CC}/2$	MAX4313/MA MAX4315	AX4314/		0.09		
Differential Phase Error	DG	$A_{VCL} = +1V/V,$ $R_{L} = 150\Omega \text{ to}$ $V_{CC}/2$	MAX4310/MA MAX4312	AX4311/		0.08		degrees
		$R_L = 150\Omega$ to $V_{CC}/2$	MAX4313/MA MAX4315	\X4314/		0.03		
			MAX4310/	f = 3kHz		-89		
			MAX4311/	f = 2kHz		-80		1
Spurious-Free Dynamic	0555	.,	MAX4312	f = 20kHz		-47		1
Range	SFDR	$V_{OUT} = 2Vp-p$	MAX4313/	f = 3kHz		-95		dBc
			MAX4314/	f = 2kHz		-72		
			MAX4315	f = 20kHz		-47		
		f = 1MHz,	MAX4310/MAX4311/MAX4312 MAX4313/MAX4314/MAX4315			-85		
Second Harmonic Distortion		V <sub>OUT</sub> = 2Vp-p				-76		dBc
		f = 1MHz,	1			-88		
Third Harmonic Distortion		$V_{OUT} = 2Vp-p$		MAX4310/MAX4311/MAX4312 MAX4313/MAX4314/MAX4315		-88 -95		dBc
		f = 1MHz,		X4311/MAX4312			+-	
Total Harmonic Distortion	THD	$V_{OUT} = 2V_{p-p}$	.717 0 ( 10 10/10/10 (				dBc	

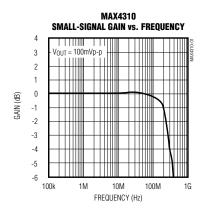
#### AC ELECTRICAL CHARACTERISTICS (continued)

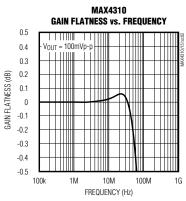
 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega, V_{CM} = 1.5V, A_{VCL} = +1V/V (MAX4310/MAX4311/MAX4312), A_{VCL} = +2V/V (MAX4313/MAX4314/MAX4315), T_A = +25°C, unless otherwise noted.)$ 

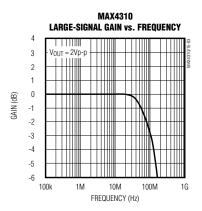
PARAMETER	SYMBOL		MIN	TYP	MAX	UNITS	
		( 40)	MAX4310/MAX4313		-95		
All-Hostile Crosstalk		f = 10MHz, V <sub>IN</sub> = 2Vp-p	MAX4311/MAX4314		-60		dB
		vIIV = 5.46-b	MAX4312MAX4315		-52		
Off-Isolation		SHDN = 0, f = 10		-82		dB	
Output Impedance	Z <sub>OUT</sub>	f = 10MHz	f = 10MHz				Ω
Input Capacitance	CIN	Channel on or of	Channel on or off				рF
Input Voltage-Noise Density	en	f = 10kHz			14		nV/√Hz
Input Current-Noise Density	in	f = 10kHz			1.3		pA/√Hz
SWITCHING CHARACTERIS	TICS						
Channel Switching Time	tsw				40		ns
Enable Time from Shutdown	ton				50		ns
Disable Time to Shutdown	toff				120		ns
Switching Transient					10		mVp-p

#### **Typical Operating Characteristics**

 $(\text{VCC} = +5\text{V}, \text{VEE} = 0\text{V}, \overline{\text{SHDN}} \geq 4\text{V}, \text{R}_{\text{L}} = 150\Omega \text{ to V}_{\text{CC}/2}, \text{V}_{\text{CM}} = 1.5\text{V}, \text{A}_{\text{VCL}} = +1\text{V/V} \text{ (MAX4310/MAX4311/MAX4312)}, \text{A}_{\text{VCL}} = +2\text{V/V} \text{ (MAX4313/MAX4314/MAX4315)}, \text{T}_{\text{A}} = +25^{\circ}\text{C}, \text{ unless otherwise noted.) }$ 

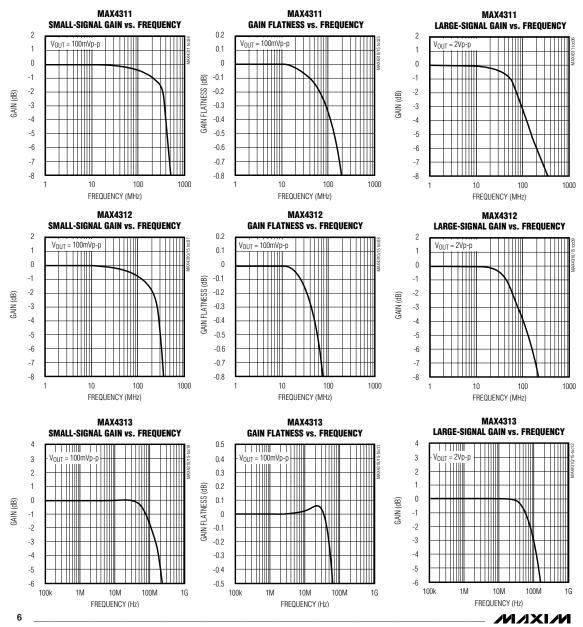






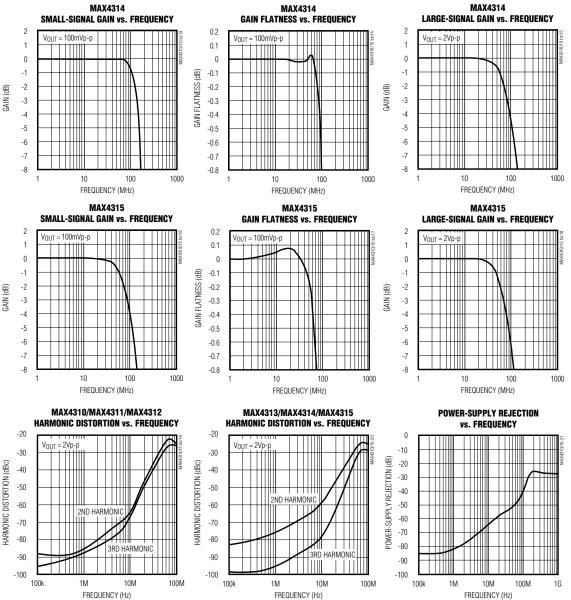
#### **Typical Operating Characteristics (continued)**

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega \text{ to } V_{CC}/2, V_{CM} = 1.5V, A_{VCL} = +1V/V \text{ (MAX4310/MAX4311/MAX4312)}, A_{VCL} = +2V/V \text{ (MAX4313/MAX4314/MAX4315)}, T_A = +25^{\circ}C, unless otherwise noted.)$ 



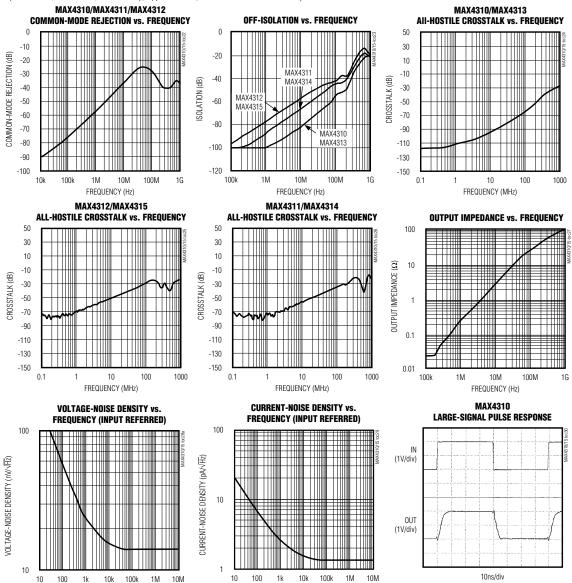
#### Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega \text{ to } V_{CC}/2, V_{CM} = 1.5V, A_{VCL} = +1V/V \text{ (MAX4310/MAX4311/MAX4312), } A_{VCL} = +2V/V \text{ (MAX4313/MAX4314/MAX4315), } T_A = +25^{\circ}C, \text{ unless otherwise noted.)}$ 



#### Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega \text{ to } V_{CC}/2, V_{CM} = 1.5V, A_{VCL} = +1V/V \text{ (MAX4310/MAX4311/MAX4312)}, A_{VCL} = +2V/V \text{ (MAX4313/MAX4314/MAX4315)}, T_A = +25^{\circ}C, unless otherwise noted.)$ 

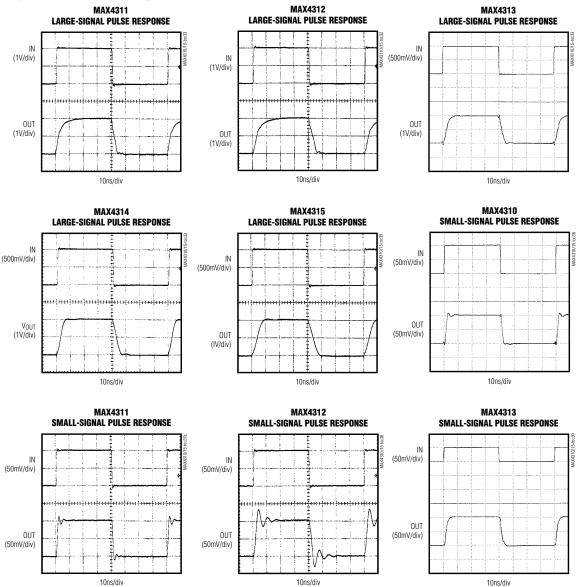


FREQUENCY (Hz)

FREQUENCY (Hz)

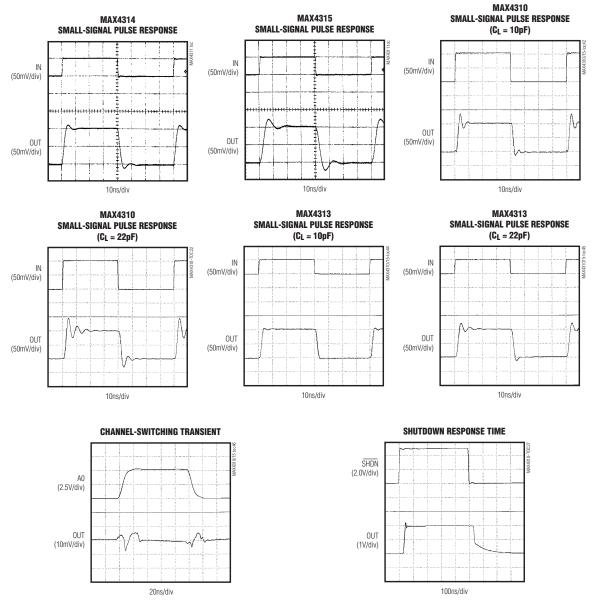
#### \_Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega \text{ to } V_{CC}/2, V_{CM} = 1.5V, A_{VCL} = +1V/V \text{ (MAX4310/MAX4311/MAX4312), } A_{VCL} = +2V/V \text{ (MAX4313/MAX4314/MAX4315), } T_A = +25^{\circ}C, \text{ unless otherwise noted.)}$ 



#### Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega \text{ to } V_{CC}/2, V_{CM} = 1.5V, A_{VCL} = +1V/V \text{ (MAX4310/MAX4311/MAX4312)}, A_{VCL} = +2V/V \text{ (MAX4313/MAX4314/MAX4315)}, T_A = +25^{\circ}C, unless otherwise noted.)$ 



### Pin Description

				PIN					
MAX4310 SO/µMAX	MA	X4311	MAX4312 SO/QSOP	MAX4313 SO/µMAX	MA	X4314	MAX4315 SO/QSOP	NAME	FUNCTION
SO/µWAX	so	QSOP	SU/QSUP	SO/µMAX	so	QSOP	SU/QSUP		
1	2	2	3	1	2	2	3	A0	Channel Address Logic Input 0
_	1	1	2	_	1	1	2	A1	Channel Address Logic Input 1
_	_	_	1	_	_	_	1	A2	Channel Address Logic Input 2
2	12	14	14	2	12	14	14	SHDN	Shutdown Input
3	4	4	4	3	4	4	4	Vcc	Positive Power Supply
4	5	5	5	4	5	5	5	IN0	Amplifier Input 0
5	7	7	6	5	7	7	6	IN1	Amplifier Input 1
_	8	10	7	_	8	10	7	IN2	Amplifier Input 2
_	10	12	8		10	12	8	IN3	Amplifier Input 3
_	-	_	9	1	_	_	9	IN4	Amplifier Input 4
_	-		10		_	_	10	IN5	Amplifier Input 5
_	_	_	11	_	_	_	11	IN6	Amplifier Input 6
_	_	_	12	_	_	_	12	IN7	Amplifier Input 7
6	11	13	13	6	11	13	13	V <sub>EE</sub>	Negative Power Supply. Ground for single-supply operation.
7	13	15	15	_	_	_	_	FB	Amplifier Feedback Input
_	_	_	_	7	13	15	15	GND	Ground
8	14	16	16	8	14	16	16	OUT	Amplifier Output
_	3, 6, 9	3, 6, 8, 9, 11	_	_	3, 6, 9	3, 6, 8, 9, 11	_	N.C.	Not connected. Tie to ground plane for optimal performance.

#### **Detailed Description**

The MAX4310/MAX4311/MAX4312 combine 2-channel. 4-channel, or 8-channel multiplexers, respectively, with an adjustable-gain output amplifier optimized for closed-loop gains of +1V/V (0dB) or greater. The MAX4313/MAX4314/MAX4315 combine 2-channel, 4channel, or 8-channel multiplexers, respectively, with a +2V/V (6dB) fixed-gain amplifier, optimized for driving back-terminated cables. These devices operate from a single supply voltage of +4V to +10.5V, or from dual supplies of ±2V to ±5.25V. The outputs may be placed in a high-impedance state and the supply current minimized by forcing the SHDN pin low. The input multiplexers feature short 40ns channel-switching times and small 10mVp-p switching transients. The input capacitance remains constant at 1pF whether the channel is on or off, providing a predictable input impedance to the signal source. These devices feature single-supply, rail-to-rail, voltage-feedback output amplifiers that achieve up to 540V/µs slew rates and up to 345MHz -3dB bandwidths. These devices also feature excellent harmonic distortion and differential gain/phase performance.

#### **Applications Information**

#### Rail-to-Rail Outputs, Ground-Sensing Input

The input common-mode range extends from the negative supply rail to VCC - 2.7V with excellent common-mode rejection. Beyond this range, multiplexer switching times may increase and the amplifier output is a nonlinear function of the input, but does not undergo phase reversal or latchup.

The output swings to within 250mV of VCC and 40mV of VEE with a  $10k\Omega$  load. With a  $150\Omega$  load to ground, the output swings from 30mV above VEE to within 730mV of

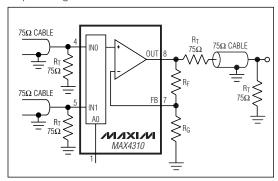


Figure 1. MAX4310 Noninverting Gain Configuration

the supply rail. Local feedback around the output stage ensures low open-loop output impedance to reduce gain sensitivity to load variations. This feedback also produces demand-driven bias current to the output transistors for ±95mA drive capability while constraining total supply current to only 6.1mA.

### Feedback and Gain Resistor Selection (MAX4310/MAX4311/MAX4312)

Select the MAX4310/MAX4311/MAX4312 gain-setting feedback (RF) and input (RG) resistors to fit your application. Large resistor values increase voltage noise and interact with the amplifier's input and PC board capacitance. This can generate undesirable poles and zeros, and can decrease bandwidth or cause oscillations. For example, a noninverting gain of +2V/V configuration (RF = RG) using  $1 k\Omega$  resistors, combined with 2pF of input capacitance and 1pF of PC board capacitance, causes a pole at 159MHz. Since this pole is within the amplifier bandwidth, it jeopardizes stability. Reducing the  $1 k\Omega$  resistors to  $100\Omega$  extends the pole frequency to 1.59 GHz, but could limit output swing by adding  $200\Omega$  in parallel with the amplifier's load resistor.

Table 1 shows suggested RF and RG values for the MAX4310/MAX4311/MAX4312 when operating in the non-inverting configuration (shown in Figure 1). These values provide optimal AC response using surface-mount resistors and good layout techniques, as discussed in the Layout and Power-Supply Bypassing section.

Stray capacitance at the FB pin causes feedback resistor decoupling and produces peaking in the frequency-response curve. Keep the capacitance at FB as low as possible by using surface-mount resistors and by avoiding the use of a ground plane beneath or beside these resistors and the FB pin. Some capacitance is unavoidable; if necessary, its effects can be neutralized by adjusting RF. Use 1% resistors to maintain consistency over a wide range of production lots.

Table 1. Bandwidth and Gain with Suggested Gain-Setting resistors (MAX4310/MAX4311/MAX4312)

GAIN (V/V)	GAIN (d B)	R <sub>F</sub> (Ω)	R <sub>G</sub> (Ω)	-3dB BW (MHz)	0.1dB BW (MHz)
1	0	0	~	280	60
2	6	500	500	80	30
5	14	500	120	20	4
10	20	500	56	10	2

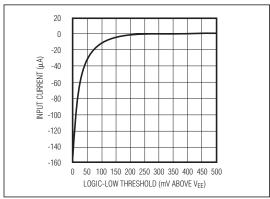


Figure 2. Logic-Low Input Current vs. VIL (SHDN, A0, A1, A2)

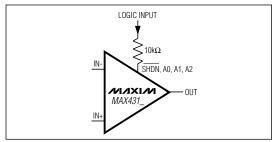


Figure 3. Circuit to Reduce Logic-Low Input Current

#### **Low-Power Shutdown Mode**

All parts feature a low-power shutdown mode that is activated by driving the  $\overline{SHDN}$  input low. Placing the amplifier in shutdown mode reduces the quiescent supply current to  $560\mu A$  and places the output into a high-impedance state, typically  $35k\Omega.$  By tying the outputs of several devices together and disabling all but one of the paralleled amplifiers' outputs, multiple devices may be paralleled to construct larger switch matrices.

For MAX4310/MAX4311/MAX4312 application circuits operating with a closed-loop gain of +2V/V or greater, consider the external-feedback network impedance of all devices used in the mux application when calculating the total load on the output amplifier of the active device. The MAX4313/MAX4314/MAX4315 have a fixed gain of +2V/V that is internally set with two 500 $\Omega$  thinfilm resistors. The impedance of the internal feedback resistors must be taken into account when operating multiple MAX4313/MAX4314/MAX4315s in large multiplexer applications. For normal operation, drive \$\overline{SHDN}\$ high. If the shutdown function is not used, connect \$\overline{SHDN}\$ to VCC.

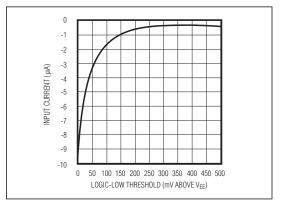


Figure 4. Logic-Low Input Current vs.  $V_{IL}$  with  $10k\Omega$  Series Resistor

#### Layout and Power-Supply Bypassing

The MAX4310–MAX4315 have very high bandwidths and consequently require careful board layout, including the possible use of constant-impedance microstrip or stripline techniques.

To realize the full AC performance of these high-speed amplifiers, pay careful attention to power-supply bypassing and board layout. The PC board should have at least two layers: a signal and power layer on one side, and a large, low-impedance ground plane on the other side. The ground plane should be as free of voids as possible, with one exception: the feedback (FB) should have as low a capacitance to ground as possible. Therefore, layers that do not incorporate a signal or power trace should not have a ground plane.

Whether or not a constant-impedance board is used, it is best to observe the following guidelines when designing the board:

- 1) Do not use wire-wrapped boards (they are too inductive) or breadboards (they are too capacitive).
- Do not use IC sockets; they increase parasitic capacitance and inductance.
- 3) Keep signal lines as short and straight as possible. Do not make 90° turns; round all corners.
- 4) Observe high-frequency bypassing techniques to maintain the amplifier's accuracy and stability.
- Use surface-mount components. They generally have shorter bodies and lower parasitic reactance, yielding better high-frequency performance than through-hole components.

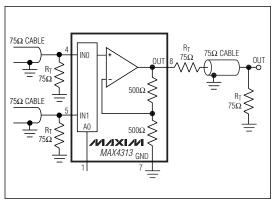


Figure 5. Video Line Driver

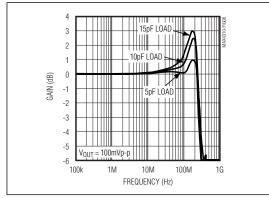


Figure 6. Small-Signal Gain vs. Frequency with a Capacitive Load and No-Isolation Resistor

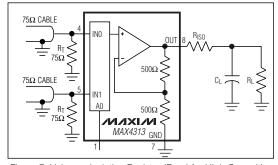


Figure 7. Using an Isolation Resistor (R<sub>ISO</sub>) for High-Capacitive Loads

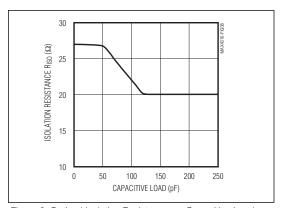


Figure 8. Optimal Isolation Resistance vs. Capacitive Load

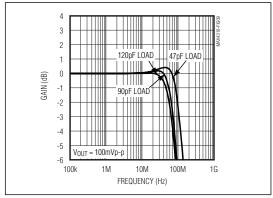


Figure 9. Small-Signal Gain vs. Frequency with a Capacitive Load and  $27\Omega$  No-Isolation Resistor

The bypass capacitors should include a 100nF, ceramic surface-mount capacitor between each supply pin and the ground plane, located as close to the package as possible. Optionally, place a 10µF tantalum capacitor at the power-supply pin's point of entry to the PC board to ensure the integrity of incoming supplies. The power-supply trace should lead directly from the tantalum capacitor to the VCC and VEE pins. To minimize parasitic inductance, keep PC traces short and use surface-mount components. If input termination resistors and output back-termination resistors are used, they should be surface-mount types, and should be placed as close to the IC pins as possible.

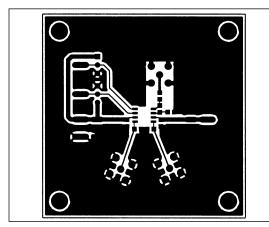


Figure 10. High-Speed EV Board Lavout—Component Side

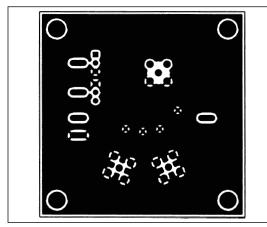


Figure 11. High-Speed EV Board Layout-Solder Side

#### **Video Line Driver**

The MAX4310–MAX4315 are well-suited to drive coaxial transmission lines when the cable is terminated at both ends, as shown in Figure 5. Cable frequency response can cause variations in the signal's flatness.

#### **Driving Capacitive Loads**

A correctly terminated transmission line is purely resistive and presents no capacitive load to the amplifier. Reactive loads decrease phase margin and may produce excessive ringing and oscillation (see *Typical Operating Characteristics*).

**Table 2. Input Control Logic** 

MAX4310/MAX4313											
SHDN	A2	<b>A</b> 1	A0	CHANNEL SELECTED							
0	_	_	Χ	None, High-Z Output							
1	_	_	0	0							
1	_	_	1	1							
	MAX4311/MAX4314										
SHDN	A2	<b>A</b> 1	A0	CHANNEL SELECTED							
0	_	Χ	Χ	None, High-Z Output							
1	_	0	0	0							
1	_	0	1	1							
1	_	1	0	2							
1	_	1	1	3							
		MAX	4312/M <i>A</i>	AX4315							
SHDN	<b>A2</b>	<b>A</b> 1	A0	CHANNEL SELECTED							
0	Χ	Χ	Χ	None, High-Z Output							
1	0	0	0	0							
1	0	0	1	1							
1	0	1	0	2							
1	0	1	1	3							
1	1	0	0	4							
1	1	0	1	5							
1	1	1	0	6							
1	1	1	1	7							

Another concern when driving capacitive loads originates from the amplifier's output impedance, which appears inductive at high frequencies. This inductance forms an L-C resonant circuit with the capacitive load, which causes peaking in the frequency response and degrades the amplifier's phase margin.

Although the MAX4310–MAX4315 are optimized for AC performance and are not designed to drive highly capacitive loads, they are capable of driving up to 20pF without oscillations. However, some peaking may occur in the frequency domain (Figure 6). To drive larger capacitive loads or to reduce ringing, add an isolation resistor between the amplifier's output and the load (Figure 7).

The value of RISO depends on the circuit's gain and the capacitive load (Figure 8). Figure 9 shows the MAX4310–MAX4315 frequency response with the isolation resistor and a capacitive load. With higher capacitive values, bandwidth is dominated by the RC network formed by RISO and CL; the bandwidth of the amplifier itself is much higher. Also note that the isolation resistor forms a divider that decreases the voltage delivered to the load.

#### **Digital Interface**

The multiplexer architecture of the MAX4310–MAX4315 ensures that no two input channels are ever connected together. Channel selection is accomplished by applying a binary code to channel address inputs. The address decoder selects input channels, as shown in Table 2. All digital inputs are CMOS compatible.

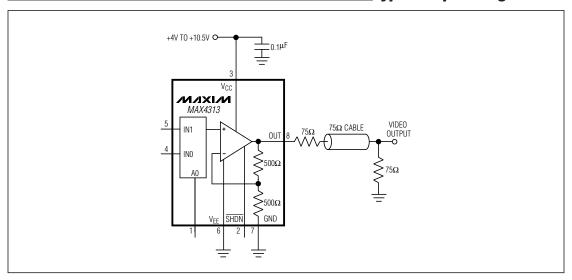
#### **High-Speed Evaluation Board**

Figures 10 and 11 show the evaluation board and present a suggested layout for the circuits. This board was developed using the techniques described in the Layout and Power-Supply Bypassing section. The smallest available surface-mount resistors were used

for feedback and back-termination to minimize their distance from the part, reducing the capacitance associated with longer lead lengths.

SMA connectors were used for best high-frequency performance. Inputs and outputs do not match a  $75\Omega$  line, but this does not affect performance since distances are extremely short. However, in applications that require lead lengths greater than one-quarter of the wavelength of the highest frequency of interest, use constant-impedance traces. Fully assembled evaluation boards are available for the MAX4313 in an SO package.

#### **Typical Operating Circuit**



#### Chip Information

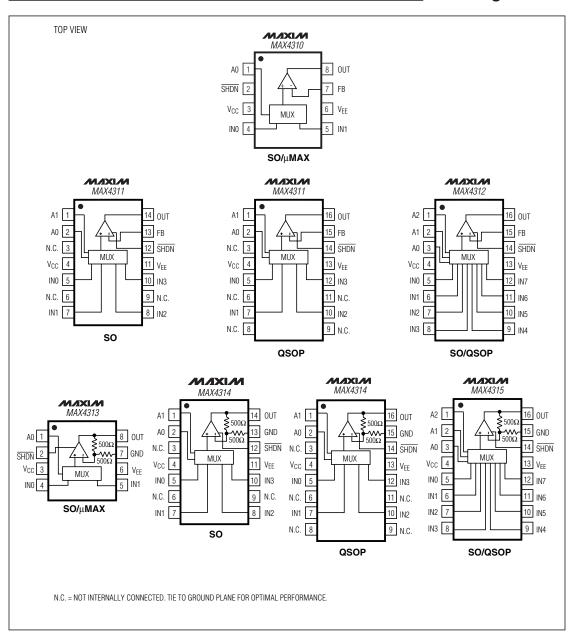
TRANSISTOR COUNT: 156

#### Package Information

For the latest package outline information, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
8 SO	S8-4	<u>21-0041</u>
8 µMAX	U8-1	21-0036
14 Narrow SO	S14-1	21-0041
16 Narrow SO	S16-1	21-0041
16 QSOP	E16-1	<u>21-0055</u>

**Pin Configurations** 



#### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	7/98	Initial release	_
1	4/99	Added new parts to data sheet.	1–20
2	12/02	Corrected MAX4314 Pin Configuration.	17
3	3/08	Updated Typical Operating Characteristics.	8

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